# DISCLOSURE NO. \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ (OFFICE USE ONLY)

# BAOSTEEL – aUSTRALIA JOINT RESEARCH & DEVELOPMENT CENTRE

# bajc

# INVENTION DISCLOSURE

# section A

**Please answer all questions in this Section. （请确保回答该部分提及的所有问题）**

**INVENTION DETAILS （发明详情）**

Project ID: \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_

Project Title: \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_

Who is the primary contact within the University for this invention? (本发明在大学内的主要联系人是谁?)

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| Name (Prof/AssPro/Dr/Mr/Mrs/Ms): | |  | | |
| Telephone |  | | E-mail |  |
| School/Centre |  | | Faculty/Institute |  |

What is the short title of the invention? (本发明的名称是什么?)

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Suggest invention protection (建议发明保护方式): Patent (专利) Know-how (商业秘密)

Invention application submitted on (发明申请提交的日期)( dd/mm/yyyy): / /20

Provide a full (and understandable) description of the invention. If more space is required, please attach additional pages to this form. Please attach drawings as appropriate.

(请提供对本发明的完整的描述. 如果需要更多的空间, 请另页提供附件和附图).

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What problems with existing technology are solved by the invention? (本发明解决了什么现有的技术问题?)

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**CONTRIBUTORS (发明人)**

Who made a material contribution to the conception of the invention and/or the design or construction of any prototype? （ 对 本 发 明 / 设计做出具体贡献的人员）

##### Contributor A

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| Title |  | | | | | Full Name | | | |  | | | | | | |
| Position | | |  | | | | | | | | | | FT/PT/Visitor/Other | | |  |
| School/Centre | |  | | | | | | | | | Faculty/Institute | | |  | | |
| Telephone | | | |  | | | | | | | | E-mail | | |  | |
| Country of citizenship | | | | | | |  | | | | | | | | | |
| Home address | | | | |  | | | | | | | | | | | |
| Description of contribution | | | | | | | | |  | | | | | | | |
| Signature of contributor | | | | | | | |  | | | | | | | | |

##### Contributor B

|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
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| Title |  | | | | | Full Name | | | |  | | | | | | |
| Position | | |  | | | | | | | | | | FT/PT/Visitor/Other | | |  |
| School/Centre | |  | | | | | | | | | Faculty/Institute | | |  | | |
| Telephone | | | |  | | | | | | | | E-mail | | |  | |
| Country of citizenship | | | | | | |  | | | | | | | | | |
| Home address | | | | |  | | | | | | | | | | | |
| Description of contribution | | | | | | | | |  | | | | | | | |
| Signature of contributor | | | | | | | |  | | | | | | | | |

##### Contributor C

|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| Title |  | | | | | Full Name | | | |  | | | | | | |
| Position | | |  | | | | | | | | | | FT/PT/Visitor/Other | | |  |
| School/Centre | |  | | | | | | | | | Faculty/Institute | | |  | | |
| Telephone | | | |  | | | | | | | | E-mail | | |  | |
| Country of citizenship | | | | | | |  | | | | | | | | | |
| Home address | | | | |  | | | | | | | | | | | |
| Description of contribution | | | | | | | | |  | | | | | | | |
| Signature of contributor | | | | | | | |  | | | | | | | | |

**If there are additional contributors, please copy this page and attach it to the form.**

Please ensure that you include names, contact details and thesis titles of any students who have worked on any aspect of the project.

# INVENTION DISCLOSURE

# section B

Completion of the information in this Section will be useful in the assessment of the commercial potential.

（您 填 写 的 下 列 信 息 将 有 助 于 对 本 发 明 进 行 商 业 化 评 估）

###### OTHER BACKGROUND INFORMATION AND SUGGESTION (其他背景信息和建议)

What is the closest existing or known technology? (最接近的现有的或已知的技术是什么?)

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Have you completed a patent or literature search for similar or related technologies? Please include those results, if available.（你是否完 成 类 似 或 相 关 技 术 的 专 利 文 献 检 索 ？如 果 做过检索, 请提供检索结 果.）

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What do you see are the possible applications and markets for the invention?

(请 说 明 本 发 明 可 能 的 应 用 和 市 场 情 况？)

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Which countries do you suggest to apply the innovation protection?

(发明人建议到哪些国家申请专利进行保护?)

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**INVENTION DISCLOSURE**

# section C

Completion of the information in this Section by BAJC office.

(由宝澳中心完成本节中的信息，提供评估意见)

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| BAJC Comments/Suggestions（宝澳中心的评估意见） | | |
|  | | |
| BAJC Officer | Signature: | Date: |

**INVENTION DISCLOSURE**

# section D

Completion of the information in this Section by Baosteel, which will feedback to BAJC

(由宝钢完成本节中的信息，并反馈给宝澳中心).

This notice issued by Baosteel on (宝钢回复发明申请的日期)( dd/mm/yyyy): / /20

Iinvention application received by Baosteel on (宝钢收到发明申请的日期)( dd/mm/yyyy): / /20

Does Baosteel approve the IP protection?

Yes (同意) No (不同意)

If yes, Baosteel suggested invention protection (如果同意，宝钢建议的保护方式)

Patent (专利) Know-how (商业秘密)

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| --- | --- | --- |
| Baosteel Official Decision/Comments/Suggestions （宝钢评估意见） | | |
|  | | |
| Authorized Baosteel Officer: | Signature: | Date: |